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Dated: May 24, 2005

Signature: 

(Arnold H. Krumholz)

Docket No.: TESSERA 3.0-272
(PATENT)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:
Delin Li

Group Art Unit: 2818

Serial No.: 10/611,390

Confirmation No.: 1533

Filed: July 1, 2003

Examiner: M. H. C. Tran

For: ASSEMBLIES HAVING STACKED
SEMICONDUCTOR CHIPS AND METHODS
OF MAKING SAME

SUBMISSION OF FORMAL DRAWINGS

MS ISSUE FEE
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

Enclosed herewith are four (4) replacement sheets of formal drawings for filing in connection with the above-identified patent application. The formal drawings are submitted in order to correct the informalities listed in form PTO-948.

In the event there are any fees due or owing in connection with this matter, please charge same to our Deposit Account No. 12-1095.

Dated: May 24, 2005

Respectfully submitted,

By 

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